

SRK1201L 1-transmitter and 2-receiver 24GHz transceiver MMIC

GENERAL DESCRIPTION

The SRK1201L is a fully integrated transceiver MMIC based on the state-of-art silicon germanium process. It operates in the 24 GHz ISM band from 24.00 to 24.25 GHz. It has 1 transmitting path that delivers 9 dBm to the antenna feed and 2 receiving paths each of that provides a 29 dB voltage gain and a 9 dB noise figure. A frequency prescaler is included to generate signals with output frequencies of 1.5 GHz and 23 kHz. On-chip baluns are included to provide single-ended RF interface. The device is controlled via SPI interface. The package is a compact 40-lead, 5 mm x 5 mm QFN.

FEATURES

- ♦ 24 GHz ISM band transceiver MMIC with 1 transmitter and 2 receivers
- ♦ RX channel voltage conversion gain: 29 dB
- ♦ RX channel noise figure: 9 dB
- ♦ RX channel input P1dB: -15 dBm
- ♦ TX output power: 9 dBm
- ♦ VCO phase noise: -103 dBc @ 1 MHz offset
- ♦ Integrated balun for single-ended RF interfaces
- ♦ Prescaler with 1.5 GHz and 23 kHz outputs
- ♦ On-chip power and temperature sensors
- ♦ DC power rating: 3.3 V and 230 mA
- ♦ 40-lead, 5 mm x 5 mm QFN package
- ♦ Fully ESD protection
- ♦ AEC-Q100 qualified

APPLICATIONS

- ♦ Automotive radars
- ♦ Industrial radars
- ♦ IoT sensors

FUNCTIONAL BLOCK DIAGRAM

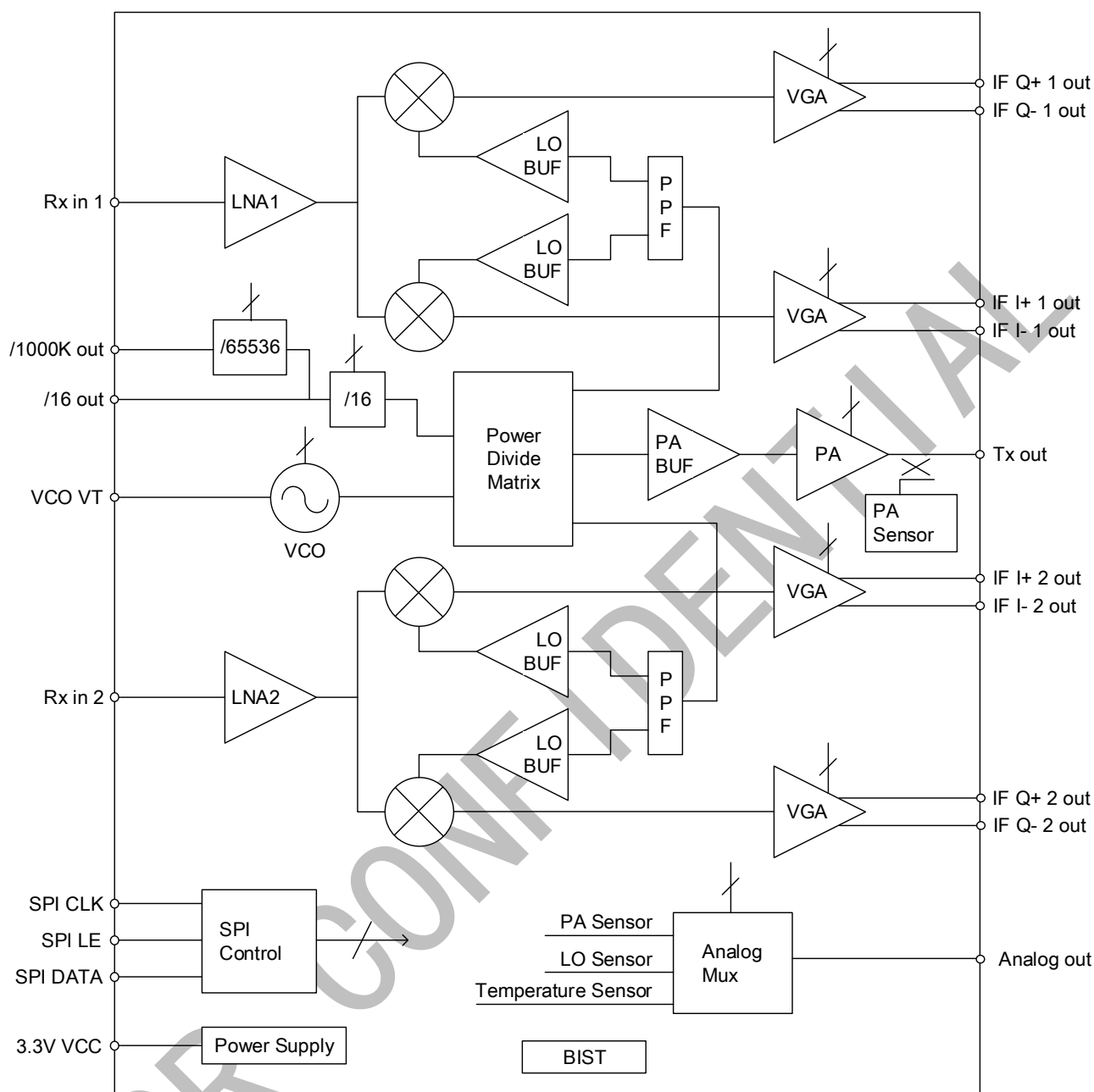


Figure 1 SOC Functional Block Diagram



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SPECIFICATIONS

VCC = 3.3 V, GND = 0 V, dBm referred to 50 Ω , operating temperature is 25 $^{\circ}\text{C}$, unless otherwise noted.

Power Supply

Table 1 Power Supply Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Note
Supply voltage	V _{cc}	3.135	3.3	3.465	V	
Supply current	I _{cc}		230		mA	

TX Section

Table 2 TX Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Note
VCO frequency range	f _{vco}	24.00		24.25	GHz	
VCO tuning voltage	V _T	0.25		2.75	V	
VCO tuning slope	$\Delta f / \Delta V_T$		-0.6		MHz/mV	
VCO temperature drift	$\Delta f / \Delta T$		1.4		MHz/ $^{\circ}\text{C}$	
VCO phase noise	P _N		-103		dBc/Hz	@ 1 MHz offset
TX port return loss	Γ_{TX}		-15		dB	with PCB matching
Max TX output power	P _{TX}		9		dBm	
TX output power tuning range			18		dB	
Q1 prescaler division ratio	D _{Q1}		16			
Q1 prescaler output power	P _{Q1}		-13		dBm	
Q1 output impedance	Z _{Q1}		50		Ω	
Q2 prescaler division ratio	D _{Q2}		2 ²⁰			
Q2 prescaler output voltage	P _{Q2}		3		V	Peak-to-peak voltage
Q2 output impedance	Z _{Q2}		1000		Ω	

RX Section

Table 3 RX Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Note
RFIN frequency range	f _{RFIN}	24.00		24.25	GHz	
RFIN port return loss	Γ_{RFIN}		-12		dB	with PCB matching
IF frequency range	f _{IF}	0		10	MHz	
IF output impedance	Z _{IF}		1000		Ω	
TX/RX isolation			-42		dB	



RFIN1 to RFIN2 isolation		-30	dB	
Voltage conversion gain	G_c	29	dB	
DSB noise figure	NF	9	dB	
Input compression point	IP_{1dB}	-15	dBm	
IQ phase imbalance		5	Degree	
IQ amplitude imbalance		1	dB	

Temperature Sensor

Table 4 Temperature Sensor Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Note
Temperature range		-40		105	°C	
Output temperature voltage	$V_{OUT,TEMP}$		1.55		V	@ 25 °C
Sensitivity			4.6		mV/°C	
Overall accuracy error				±15	°C	

Power Sensor

Table 5 Power Sensor Characteristics

Parameter	Symbol	Min	Typ	Max	Units	Note
Power range		-10		15	dBm	
TX power sensor			1.65		V	@ 10 dBm
LO power sensor			1.32		V	@ 2 dBm

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

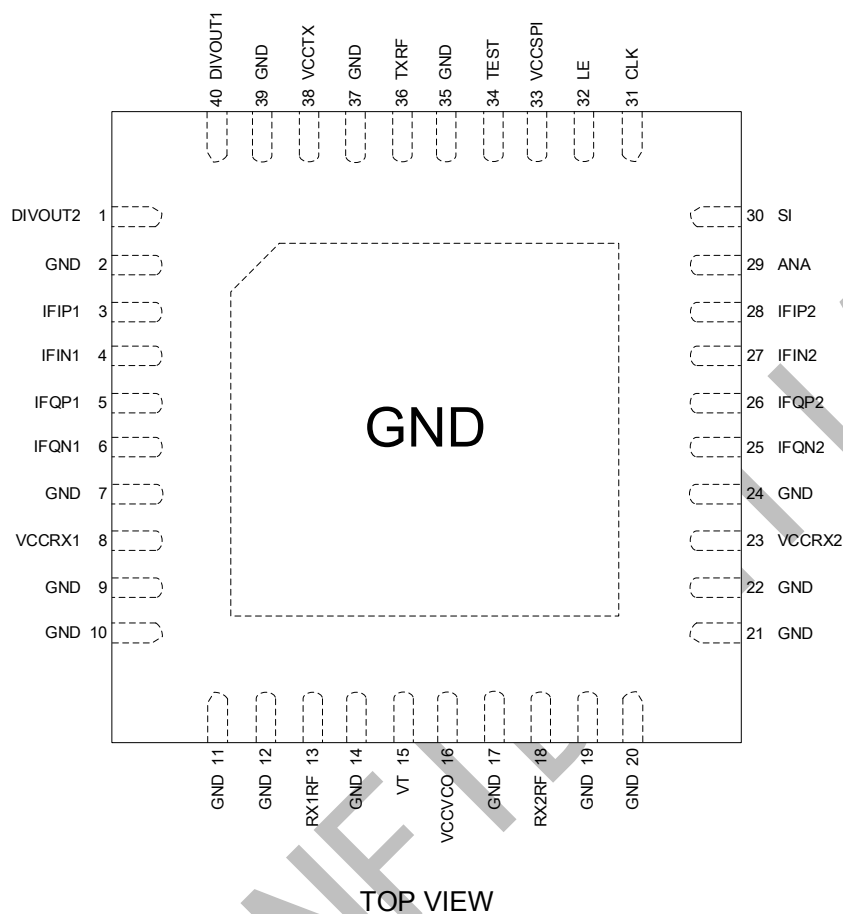


Figure 2 Pin Configuration

Table 5 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	DIVOUT2	Prescaler output 23 kHz
2, 7, 9, 10, 11, 12, 14, 17, 19, 20, 21, 22, 24, 35, 37, 39	GND	RF or DC ground
3	IFIP1	In phase IF output at RX1
4	IFIN1	Complementary in phase IF output at RX1
5	IFQP1	Quadrature phase IF output at RX1
6	IFQN1	Complementary quadrature phase IF output at RX1
8	VCCR1	Supply voltage for RX1
13	RX1RF	RF input at RX1
15	VT	VCO tuning input
16	VCCVCO	Supply voltage for VCO
18	RX2RF	RF input at RX2
23	VCCR2	Supply voltage for RX2

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25	IFQN2	Complementary quadrature phase IF output at RX2
26	IFQP2	Quadrature phase IF output at RX2
27	IFIN2	Complementary in phase IF output at RX2
28	IFIP2	In phase IF output at RX2
29	ANA	Analog output
30	SI	SPI data input
31	CLK	SPI clock input
32	LE	SPI load enable, low active
33	VCCSPI	Supply voltage for SPI
34	TEST	Test pin , be floated
36	TXRF	RF output at TX
38	VCCTX	Supply voltage for TX
40	DIVOUT1	Prescaler output 1.5 GHz

SPI

1. Three control signals : SI(data), CLK(clock), LE(load enable)
2. The data (MSB first) is clocked into the 32-bit input shift register on each rising edge of CLK , and is written in the latches at the rising edge of LE
3. There are totally 8 groups of latches which determined by the state of the last 3 data bits

Register 0

ADDRESS	DB0	0
	DB1	0
	DB2	0
PA	DB3	V1
	DB4	V2
	DB5	V3
	DB6	V4
	DB7	EN
PRESCALE2	DB8	EN
VCO	DB9	EN
PRESCALE1	DB10	EN
Reserved	DB11	0
	DB12	0
	DB13	0
	DB14	0
	DB15	0
	DB16	0
	DB17	0
	DB18	0
	DB19	0
	DB20	0
	DB21	0
DB22	0	
DB23	0	
DB24	0	
DB25	0	
DB26	0	
DB27	0	
DB28	0	
DB29	0	
DB30	0	
DB31	0	

Register 1

ADDRESS		Reserved																																																													
DB0	1	DB1	0	DB2	0	DB3	0	DB4	0	DB5	0	DB6	0	DB7	0	DB8	0	DB9	0	DB10	0	DB11	0	DB12	0	DB13	0	DB14	0	DB15	0	DB16	0	DB17	0	DB18	0	DB19	0	DB20	0	DB21	0	DB22	0	DB23	0	DB24	0	DB25	0	DB26	0	DB27	0	DB28	0	DB29	0	DB30	0	DB31	0

Register 2

ADDRESS	DB0	0
	DB1	1
	DB2	0
LNA	DB3	EN
IQ MIXER	DB4	DCOC_Q1
	DB5	DCOC_Q2
	DB6	DCOC_Q3
	DB7	DCOC_Q4
	DB8	DCOC_Q5
	DB9	DCOC_I1
	DB10	DCOC_I2
	DB11	DCOC_I3
	DB12	DCOC_I4
	DB13	DCOC_I5
	DB14	CTRL
	DB15	EN
	DB16	EN
LO BUFFER	DB17	D1
VGA	DB18	D2
	DB19	D3
	DB20	EN
	DB21	0
	DB22	0
Reserved	DB23	0
	DB24	0
	DB25	0
	DB26	0
	DB27	0
	DB28	0
	DB29	0
	DB30	0
	DB31	0

Register 3

ADDRESS	DB0	1
	DB1	1
	DB2	0
LNA	DB3	EN
IQ MIXER	DB4	DCOC_Q1
	DB5	DCOC_Q2
	DB6	DCOC_Q3
	DB7	DCOC_Q4
	DB8	DCOC_Q5
	DB9	DCOC_I1
	DB10	DCOC_I2
	DB11	DCOC_I3
	DB12	DCOC_I4
	DB13	DCOC_I5
	DB14	CTRL
	DB15	EN
	LO BUFFER	DB16
VGA	DB17	D1
	DB18	D2
	DB19	D3
	DB20	EN
Reserved	DB21	0
	DB22	0
	DB23	0
	DB24	0
	DB25	0
	DB26	0
	DB27	0
	DB28	0
	DB29	0
	DB30	0
	DB31	0

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Register 4

Reserved												ADDRESS		
												DB0	DB1	DB2
0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
DB31	DB30	DB29	DB28	DB27	DB26	DB25	DB24	DB23	DB22	DB21	DB20	DB19	DB18	DB17
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Register 5

Reserved												ADDRESS		
												DB0	DB1	DB2
1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
DB31	DB30	DB29	DB28	DB27	DB26	DB25	DB24	DB23	DB22	DB21	DB20	DB19	DB18	DB17
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Register 6

Reserved												ADDRESS		
												DB0	DB1	DB2
0	0	0	0	0	0	0	0	0	0	0	0	0	1	1
DB31	DB30	DB29	DB28	DB27	DB26	DB25	DB24	DB23	DB22	DB21	DB20	DB19	DB18	DB17
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	Reserved	MXOUT CONTROL	DB8	DB7	DB6	DB5	DB4
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
DB3	DB2	DB1	DB0	EN1	EN2	EN3	EN4	EN5	EN6	EN7	EN8	EN9	EN10	EN11
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Register 7

Reserved												ADDRESS		
												DB0	DB1	DB2
1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
DB31	DB30	DB29	DB28	DB27	DB26	DB25	DB24	DB23	DB22	DB21	DB20	DB19	DB18	DB17
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Figure 3 Register map



Register 0 (TX Control Register)

With Register DB[2:0] set to [0,0,0], the TX control register is programmed as shown in Figure 3.

Prescaler1

Setting DB10 to 1 enables the prescaler1, setting DB10 to 0 disables the prescaler1.

VCO

Setting DB9 to 1 enables the VCO, setting DB9 to 0 disables the VCO.

Prescaler2

Setting DB8 to 1 enables the prescaler2, setting DB8 to 0 disables the prescaler2.

PA

Setting DB7 to 1 enables the PA, setting DB7 to 0 disables the PA.

The PA setting is controlled by DB[6:3]. The truth table is in Table 6.

Table 6 PA setting truth table

V4	V3	V2	V1	SETTING
0	0	0	0	Minimum PA output power
0	0	0	1	PA power increasing progressively
0	0	1	0	
0	0	1	1	
0	1	0	0	
0	1	0	1	
0	1	1	0	
0	1	1	1	
1	0	0	0	
1	0	0	1	
1	0	1	0	
1	0	1	1	
1	1	0	0	
1	1	0	1	
1	1	1	0	
1	1	1	1	Maximum PA output power

Register 2 (RX1 Control Register)

With Register DB[2:0] set to [0,1,0], the RX1 control register is programmed as shown in Figure 3.

VGA

Setting DB20 to 1 enables the VGA, setting DB20 to 0 disables the VGA.

The VGA setting is controlled by DB[19:17]. The truth table is in Table 7.

Table 7 RX1 VGA setting truth table

D3	D2	D1	SETTING
0	0	0	Minimum gain
0	0	1	Gain increasing
0	1	0	
0	1	1	



1	0	0	progressively
1	0	1	
1	1	0	
1	1	1	Maximum gain

LO Buffer

Setting DB16 to 1 enables the LO Buffer, setting DB16 to 0 disables the LO Buffer.

IQ Mixer

Setting DB15 to 1 enables the IQ Mixer, setting DB15 to 0 disables the IQ Mixer.

Setting DB14 to 0, the voltage gain is 6dB; when setting DB14 to 1, the voltage gain is 3dB.

The DB[13:9] control the I path IF value as below truth table Table 8.

Table 8 RX1 / path IF value setting truth table

DB13	DB12	DB11	DB10	DB9	IFIP	IFIN
X	0	0	0	0	0	0
0	0	0	0	1	-ΔV	0
1	0	0	0	1	0	-ΔV
0	0	0	1	0	-2ΔV	0
1	0	0	1	0	0	2-ΔV
0	0	0	1	1	-3ΔV	0
1	0	0	1	1	0	-3ΔV
0	0	1	0	0	-4ΔV	0
1	0	1	0	0	0	-4ΔV
0	0	1	0	1	-5ΔV	0
1	0	1	0	1	0	-5ΔV
0	0	1	1	0	-6ΔV	0
1	0	1	1	0	0	-6ΔV
0	0	1	1	1	-7ΔV	0
1	0	1	1	1	0	-7ΔV
0	1	0	0	0	-8ΔV	0
1	1	0	0	0	0	-8ΔV
0	1	0	0	1	-9ΔV	0
1	1	0	0	1	0	-9ΔV
0	1	0	1	0	-10ΔV	0
1	1	0	1	0	0	-10ΔV
0	1	0	1	1	-11ΔV	0
1	1	0	1	1	0	-11ΔV
0	1	1	0	0	-12ΔV	0
1	1	1	0	0	0	-12ΔV
0	1	1	0	1	-13ΔV	0
1	1	1	0	1	0	-13ΔV
0	1	1	1	0	-14ΔV	0



1	1	1	1	0	0	-14ΔV
0	1	1	1	1	-15ΔV	0
1	1	1	1	1	0	-15ΔV

The DB[8:4] control the Q path IF value as below truth table Table 9.

Table 9 RX1 Q path IF value setting truth table

DB8	DB7	DB6	DB5	DB4	IFQP	IFQN
X	0	0	0	0	0	0
0	0	0	0	1	-ΔV	0
1	0	0	0	1	0	-ΔV
0	0	0	1	0	-2ΔV	0
1	0	0	1	0	0	2-ΔV
0	0	0	1	1	-3ΔV	0
1	0	0	1	1	0	-3ΔV
0	0	1	0	0	-4ΔV	0
1	0	1	0	0	0	-4ΔV
0	0	1	0	1	-5ΔV	0
1	0	1	0	1	0	-5ΔV
0	0	1	1	0	-6ΔV	0
1	0	1	1	0	0	-6ΔV
0	0	1	1	1	-7ΔV	0
1	0	1	1	1	0	-7ΔV
0	1	0	0	0	-8ΔV	0
1	1	0	0	0	0	-8ΔV
0	1	0	0	1	-9ΔV	0
1	1	0	0	1	0	-9ΔV
0	1	0	1	0	-10ΔV	0
1	1	0	1	0	0	-10ΔV
0	1	0	1	1	-11ΔV	0
1	1	0	1	1	0	-11ΔV
0	1	1	0	0	-12ΔV	0
1	1	1	0	0	0	-12ΔV
0	1	1	0	1	-13ΔV	0
1	1	1	0	1	0	-13ΔV
0	1	1	1	0	-14ΔV	0
1	1	1	1	0	0	-14ΔV
0	1	1	1	1	-15ΔV	0
1	1	1	1	1	0	-15ΔV



LNA

Setting DB3 to 1 enables the LNA, setting DB3 to 0 disables the LNA.

Register 3 (RX2 Control Register)

With Register DB[2:0] set to [0,1,1], the RX2 control register is programmed as shown in Figure 3.

VGA

Setting DB20 to 1 enables the VGA, setting DB20 to 0 disables the VGA.

The VGA setting is controlled by DB[19:17]. The truth table is in Table 10.

Table 10 RX2 VGA setting truth table

D3	D2	D1	SETTING
0	0	0	Minimum gain
0	0	1	Gain increasing progressively
0	1	0	
0	1	1	
1	0	0	
1	0	1	
1	1	0	Maximum gain
1	1	1	

LO Buffer

Setting DB16 to 1 enables the LO Buffer, setting DB16 to 0 disables the LO Buffer.

IQ Mixer

Setting DB15 to 1 enables the IQ Mixer, setting DB15 to 0 disables the IQ Mixer.

Setting DB14 to 0, the voltage gain is 6dB; when setting DB14 to 1, the voltage gain is 3dB.

The DB[13:9] control the I path IF value as below truth table Table 11.

Table 11 RX2 / path IF value setting truth table

DB13	DB12	DB11	DB10	DB9	IFIP	IFIN
X	0	0	0	0	0	0
0	0	0	0	1	-ΔV	0
1	0	0	0	1	0	-ΔV
0	0	0	1	0	-2ΔV	0
1	0	0	1	0	0	2-ΔV
0	0	0	1	1	-3ΔV	0
1	0	0	1	1	0	-3ΔV
0	0	1	0	0	-4ΔV	0
1	0	1	0	0	0	-4ΔV
0	0	1	0	1	-5ΔV	0
1	0	1	0	1	0	-5ΔV
0	0	1	1	0	-6ΔV	0
1	0	1	1	0	0	-6ΔV



0	0	1	1	1	-7ΔV	0
1	0	1	1	1	0	-7ΔV
0	1	0	0	0	-8ΔV	0
1	1	0	0	0	0	-8ΔV
0	1	0	0	1	-9ΔV	0
1	1	0	0	1	0	-9ΔV
0	1	0	1	0	-10ΔV	0
1	1	0	1	0	0	-10ΔV
0	1	0	1	1	-11ΔV	0
1	1	0	1	1	0	-11ΔV
0	1	1	0	0	-12ΔV	0
1	1	1	0	0	0	-12ΔV
0	1	1	0	1	-13ΔV	0
1	1	1	0	1	0	-13ΔV
0	1	1	1	0	-14ΔV	0
1	1	1	1	0	0	-14ΔV
0	1	1	1	1	-15ΔV	0
1	1	1	1	1	0	-15ΔV

The DB[8:4] control the Q path IF value as below truth table Table 12.

Table 12 RX2 Q path IF value setting truth table

DB8	DB7	DB6	DB5	DB4	IFQP	IFQN
X	0	0	0	0	0	0
0	0	0	0	1	-ΔV	0
1	0	0	0	1	0	-ΔV
0	0	0	1	0	-2ΔV	0
1	0	0	1	0	0	2-ΔV
0	0	0	1	1	-3ΔV	0
1	0	0	1	1	0	-3ΔV
0	0	1	0	0	-4ΔV	0
1	0	1	0	0	0	-4ΔV
0	0	1	0	1	-5ΔV	0
1	0	1	0	1	0	-5ΔV
0	0	1	1	0	-6ΔV	0
1	0	1	1	0	0	-6ΔV
0	0	1	1	1	-7ΔV	0
1	0	1	1	1	0	-7ΔV
0	1	0	0	0	-8ΔV	0
1	1	0	0	0	0	-8ΔV
0	1	0	0	1	-9ΔV	0
1	1	0	0	1	0	-9ΔV



0	1	0	1	0	-10ΔV	0
1	1	0	1	0	0	-10ΔV
0	1	0	1	1	-11ΔV	0
1	1	0	1	1	0	-11ΔV
0	1	1	0	0	-12ΔV	0
1	1	1	0	0	0	-12ΔV
0	1	1	0	1	-13ΔV	0
1	1	1	0	1	0	-13ΔV
0	1	1	1	0	-14ΔV	0
1	1	1	1	0	0	-14ΔV
0	1	1	1	1	-15ΔV	0
1	1	1	1	1	0	-15ΔV

LNA

Setting DB3 to 1 enables the LNA, setting DB3 to 0 disables the LNA.

Register 6 (Sensor enable and ANA output selection)

With Register DB[2:0] set to [1,1,0], the sensor enable and ANA output signal selection is programmed as shown in Figure 3.

Sensor enable

Setting DB6 to 1 enables the power sensor of PPF LO buffer input in RX1, setting DB6 to 0 disable it.

Setting DB5 to 1 enables the power sensor to PPF LO buffer input in RX2, setting DB5 to 0 disable it.

Setting DB4 to 1 enables the power sensor of PA output and temperature sensor nearby PA, setting DB4 to 0 disable them.

Setting DB3 to 1 enables the power sensor of PA buffer input, setting DB3 to 0 disable it.

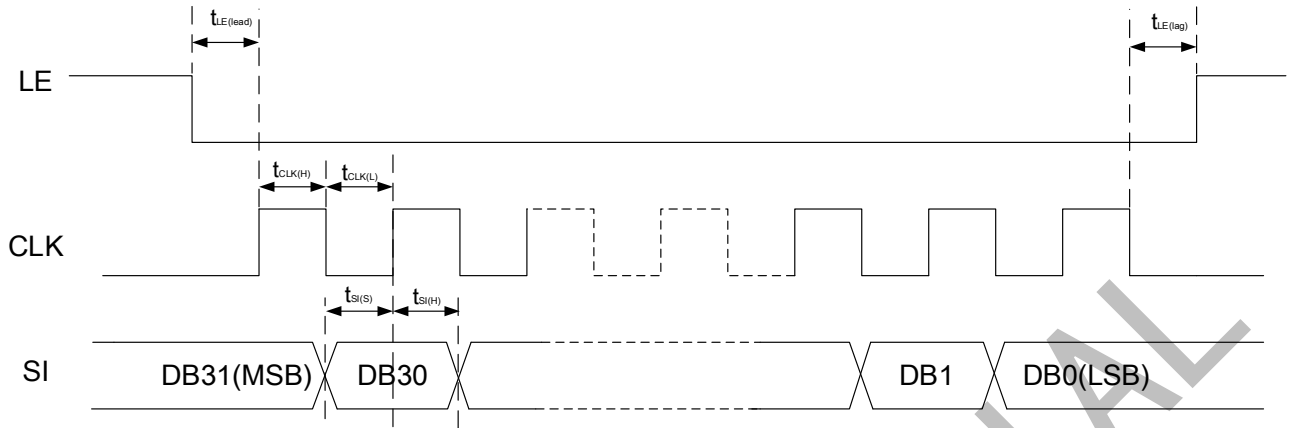
ANA output selection

The DB[12:10] control the ANA output signal selection as below truth table Table 13.

Table 13 ANA output signal selection truth table

CTRL3	CTRL2	CTRL1	OUTPUT
0	0	0	NA
0	0	1	NA
0	1	0	Power sensor of PA output power
0	1	1	Temperature sensor nearby PA
1	0	0	Power sensor of input to PPF LO Buffer in RX2
1	0	1	Power sensor of input to PPF LO Buffer in RX1
1	1	0	Power sensor of input to PA Buffer
1	1	1	NA

TIMING SPECIFICATIONS



Parameter	Symbol	Min	Max	Unit
CLK frequency	f_{CLK}		50	MHz
LE lead time	$t_{LE(lead)}$	20		ns
LE lag time	$t_{LE(lag)}$	20		ns
CLK high duration	$t_{CLK(H)}$	10		ns
CLK low duration	$t_{CLK(L)}$	10		ns
SI to CLK setup time	$t_{SI(S)}$	10		ns
SI to CLK hold time	$t_{SI(H)}$	10		ns

PACKAGE DIMENSIONS

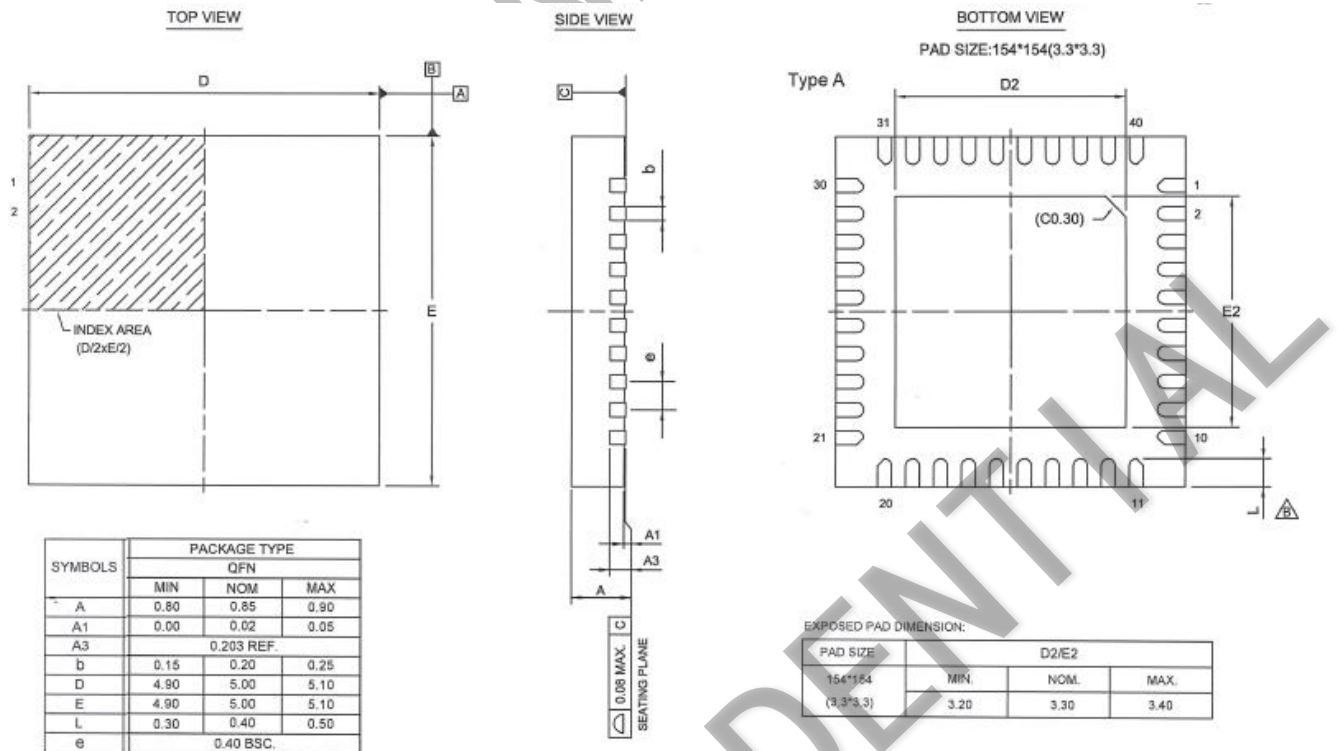


Figure 4 40-Lead QFN Package Dimensions

APPLICATION BOARD

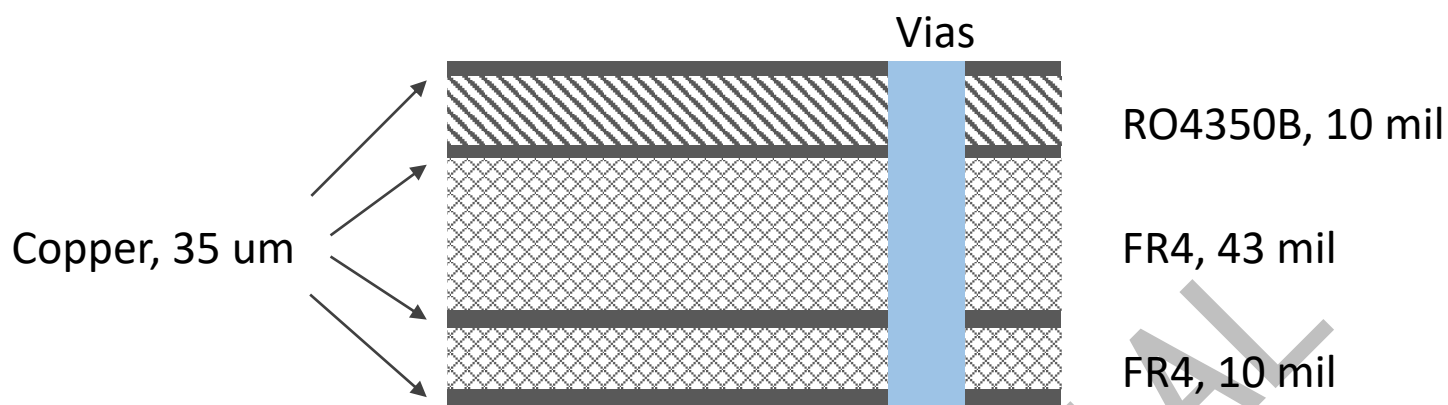


Figure 5 PCB stack profile

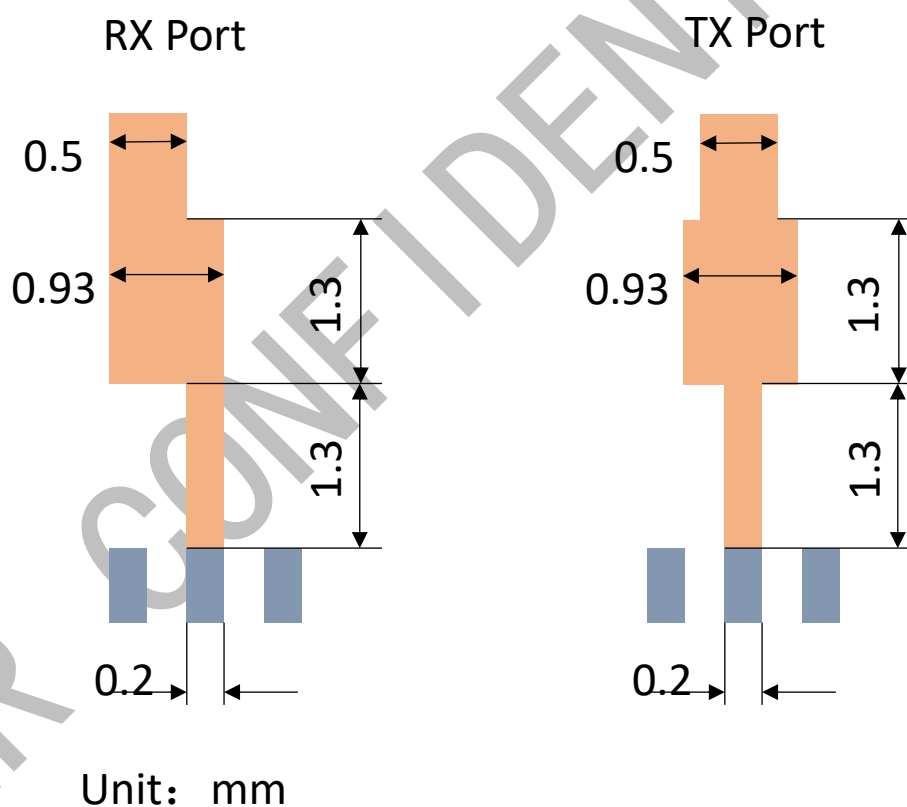


Figure 6 Matching structure dimensions

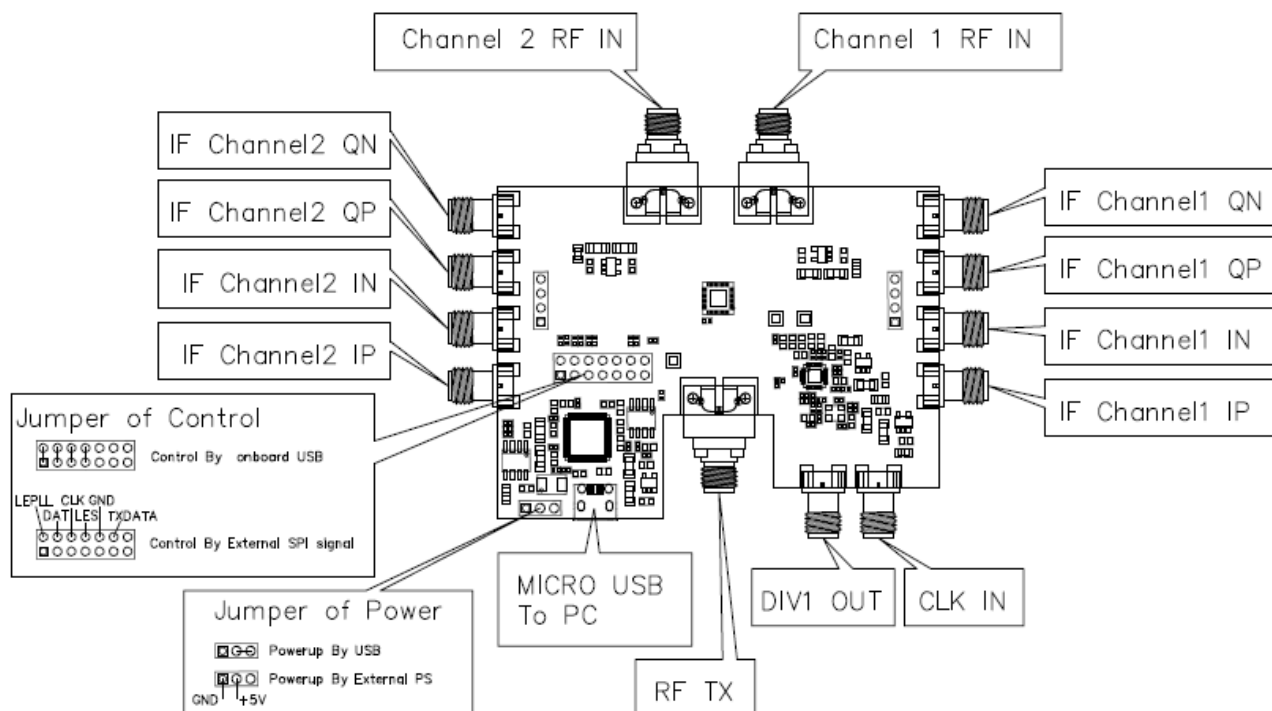


Figure 7 Evaluation board illustration